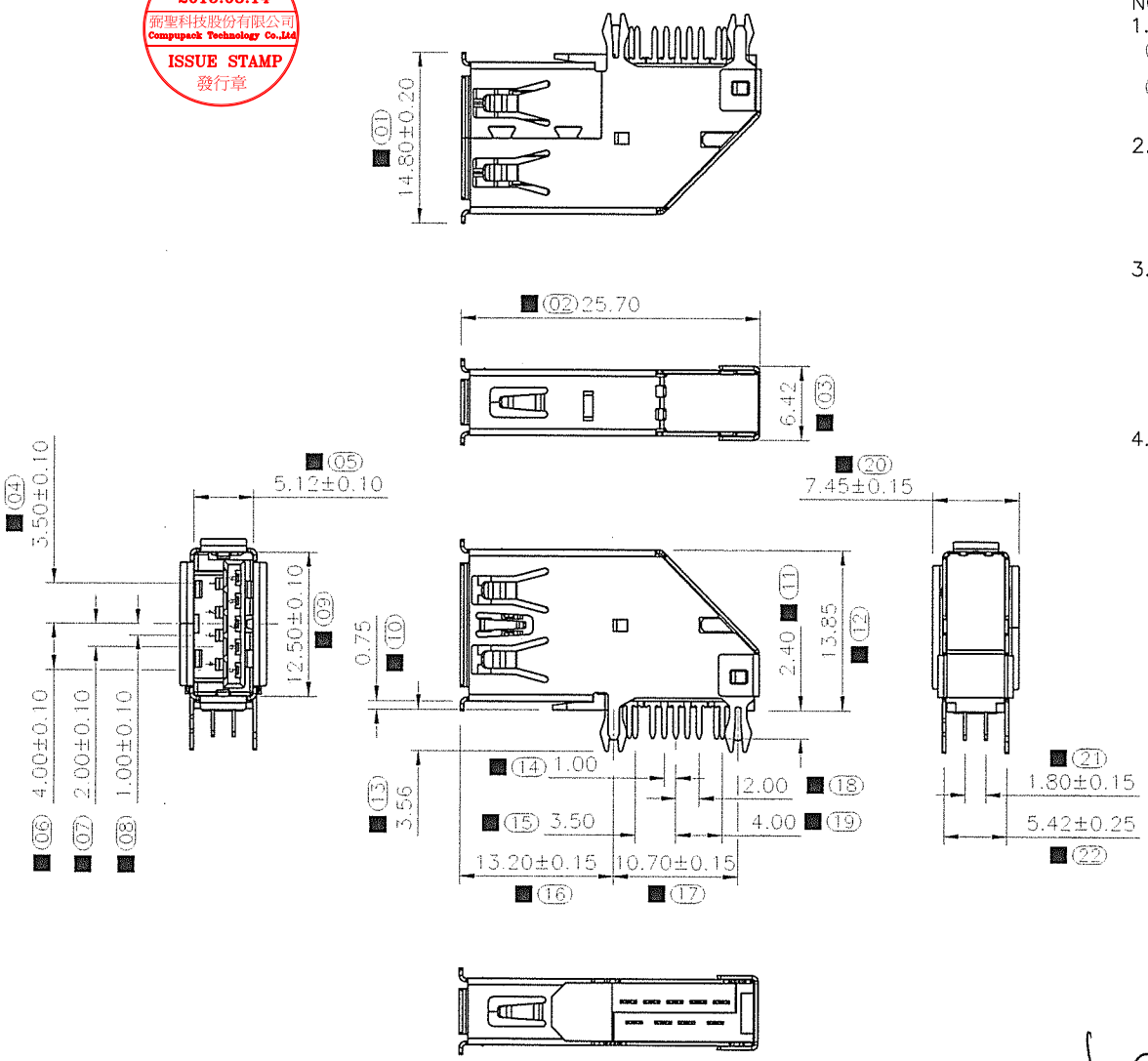
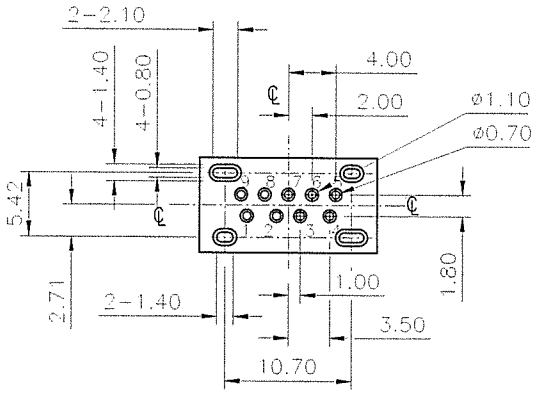
C圖版次：A0

文管中心
2015.08.14
滿聖科技股份有限公司
Compupack Technology Co.,Ltd
ISSUE STAMP
發行章



NOTES:
1. MATERIAL:
   (01) 1.1 INSULATOR: LCP, UL94V-0, COLOR: BLUE.
   (02) 1.2 CONTACT#1 ~ #4: PHOSPHOR BRONZE,
   (03) 1.3 CONTACT#5 ~ #9: BRASS.
   1.4 SHELL: STAINLESS STEEL,
2. FINISH:
   2.1 CONTACTS: GOLD PLATED ON CONTACT AREA, 80μ" MIN. TIN PLATED ON SOLDER AREA, 20μ" MIN. NICKEL UNDERPLATED OVERALL.
   2.2 SHELL: 50μ" MIN. NICKEL PLATED ENTIRE.
3. SPECIFICATIONS:
   3.1 CURRENT RATING: 1.8A FOR #1 & #4
   0.25A FOR OTHER PIN
   3.2 CONTACT RESISTANCE: 30mΩ MAX. FOR #1 & #4
   50mΩ MAX. FOR OTHER PIN
   3.3 INSULATION RESISTANCE: 100MΩ MIN.
   3.4 DIELECTRIC WITHSTANDING VOLTAGE: AC 100V/MINUTE.
4. OTHERS:
   4.1 THIS COMPONENT AND ITS HOMOGENEOUS SUB COMPONENTS ARE RoHS COMPLIANT.
   4.2 RESISTANCE TO SOLDERING HEAT 245°C FOR 5 SECONDS.
   4.3 " ■ " MARKED AS QC INSPECTION ON SIZE.
   4.4 " (XX) " MARKED AS FAI INSPECTION ON SIZE.



RECOMMENDED PCB LAYOUT
COMPONENT SIDE
TOLERANCE: ±0.05mm

8/14 2015

TRAY	G/F	5U1.2117G-63860.109	ACNUB210133-001
PACKING	PLATING	SUPPLIER'S P/N	CPC P/N

REV.	DESCRIPTION	ECN NO.	NAME	DATE
A1	MODIFY CONTACTS MATERIAL (01A) (02A)	ECN1508002	Rock	13-Aug-2015
A0	FIRST RELEASED	-	MILO	20-MAR-2015

REVISIONS

DIM.	TOL.
X.	± 0.50
X.X	± 0.38
X.XX	± 0.25
X.XXX	± 0.10
ANGLL	± 3°

TITLE: USB 3.0 A TYPE, 9P, UP RIGHT TYPE, DIP, REC, H13.85mm

DWG. NO.: A- ACNUB210133

UNIT:	DWG SIZE:	SCALE:	SHEET:	LAYER:
mm	A4	none	1 OF 1	CA144

DRAWN: Rock
CHECKED: Vic
APPROVED: Kim

CompuPack
RFQ NO.: Q1502013&Q1503073

ARTICLE: CPC-CN-002-C

THIS DRAWING IS A CONTROLLED DOCUMENT.